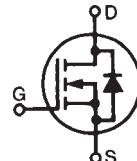


Polar™
Power MOSFETs

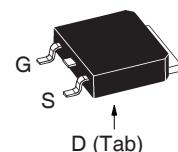
IXTY1R4N100P
IXTA1R4N100P
IXTP1R4N100P

N-Channel Enhancement Mode
Avalanche Rated

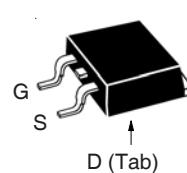


V_{DSS} = 1000V
I_{D25} = 1.4A
R_{DS(on)} ≤ 11.8Ω

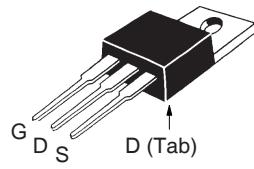
TO-252 (IXTY)



TO-263 AA (IXTA)



TO-220AB (IXTP)



G = Gate D = Drain
S = Source Tab = Drain

Symbol	Test Conditions	Maximum Ratings		
V_{DSS}	T _J = 25°C to 150°C	1000		V
V_{DGR}	T _J = 25°C to 150°C, R _{GS} = 1MΩ	1000		V
V_{GSS}	Continuous	±20		V
V_{GSM}	Transient	±30		V
I_{D25}	T _C = 25°C	1.4		A
I_{DM}	T _C = 25°C, Pulse Width Limited by T _{JM}	3.0		A
I_A	T _C = 25°C	1.4		A
E_{AS}	T _C = 25°C	100		mJ
dv/dt	I _S ≤ I _{DM} , V _{DD} ≤ V _{DSS} , T _J ≤ 150°C	10		V/ns
P_D	T _C = 25°C	63		W
T_J		-55 ... +150		°C
T_{JM}		150		°C
T_{stg}		-55 ... +150		°C
T_L	1.6mm (0.062) from Case for 10s	300		°C
T_{SOLD}	Plastic Body for 10s	260		°C
F_c	Mounting Force (TO-263)	10..65/2.2..14.6		N/lb.
M_d	Mounting Torque (TO-220)	1.13 / 10		Nm/lb.in.
Weight	TO-252	0.35		g
	TO-263	2.50		g
	TO-220	3.00		g

Symbol	Test Conditions (T _J = 25°C, Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max.
BV_{DSS}	V _{GS} = 0V, I _D = 250μA	1000		V
V_{GS(th)}	V _{DS} = V _{GS} , I _D = 50μA	2.5		4.5 V
I_{GSS}	V _{GS} = ±20V, V _{DS} = 0V			±50 nA
I_{DSS}	V _{DS} = V _{DSS} , V _{GS} = 0V T _J = 125°C			5 μA 150 μA
R_{DS(on)}	V _{GS} = 10V, I _D = 0.5 • I _{D25} , Note 1			11.8 Ω

Features

- International Standard Packages
- Low R_{DS(on)} and Q_G
- Avalanche Rated
- Low Package Inductance
- Fast Intrinsic Rectifier

Advantages

- High Power Density
- Easy to Mount
- Space Savings

Applications

- Switch-Mode and Resonant-Mode Power Supplies
- DC-DC Converters
- Laser Drivers
- AC and DC Motor Drives
- Robotics and Servo Controls

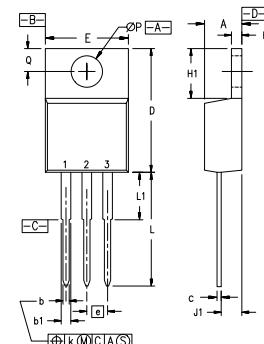
Symbol	Test Conditions ($T_J = 25^\circ\text{C}$, Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max
g_{fs}	$V_{DS} = 20\text{V}$, $I_D = 0.5 \cdot I_{D25}$, Note 1	0.70	1.10	S
C_{iss} C_{oss} C_{rss}	$V_{GS} = 0\text{V}$, $V_{DS} = 25\text{V}$, $f = 1\text{MHz}$	450 27 6	pF pF pF	
$t_{d(on)}$ t_r $t_{d(off)}$ t_f	Resistive Switching Times $V_{GS} = 10\text{V}$, $V_{DS} = 0.5 \cdot V_{DSS}$, $I_D = 0.5 \cdot I_{D25}$ $R_G = 30\Omega$ (External)	25 35 65 28	ns ns ns ns	
$Q_{g(on)}$ Q_{gs} Q_{gd}	$V_{GS} = 10\text{V}$, $V_{DS} = 0.5 \cdot V_{DSS}$, $I_D = 0.5 \cdot I_{D25}$	17.8 2.8 9.9	nC nC nC	
R_{thJC} R_{thCS}	TO-220	0.50	2.0 $^\circ\text{C}/\text{W}$ 2.0 $^\circ\text{C}/\text{W}$	

Source-Drain Diode

Symbol	Test Conditions ($T_J = 25^\circ\text{C}$, Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max
I_s	$V_{GS} = 0\text{V}$		1.4	A
I_{SM}	Repetitive, Pulse Width Limited by T_{JM}		4.2	A
V_{SD}	$I_F = I_S$, $V_{GS} = 0\text{V}$, Note 1		1.5	V
t_{rr}	$I_F = 1.4\text{A}$, $-di/dt = 100\text{A}/\mu\text{s}$, $V_R = 100\text{V}$, $V_{GS} = 0\text{V}$	750		ns

Note 1: Pulse test, $t \leq 300\mu\text{s}$, duty cycle, $d \leq 2\%$.

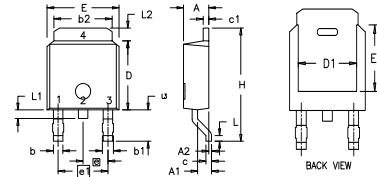
TO-220 (IXTP) Outline



Pins: 1 - Gate
3 - Source 2 - Drain

SYM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.170	.190	4.32	4.83
b	.025	.040	0.64	1.02
b1	.045	.065	1.15	1.65
c	.014	.022	0.35	0.56
D	.580	.630	14.73	16.00
E	.390	.420	9.91	10.66
e	.100	BSC	2.54	BSC
F	.045	.055	1.14	1.40
H1	.230	.270	5.85	6.85
J1	.090	.110	2.29	2.79
k	0	.015	0	0.38
L	.500	.550	12.70	13.97
L1	.110	.230	2.79	5.84
$\emptyset P$.139	.161	3.53	4.08
Q	.100	.125	2.54	3.18

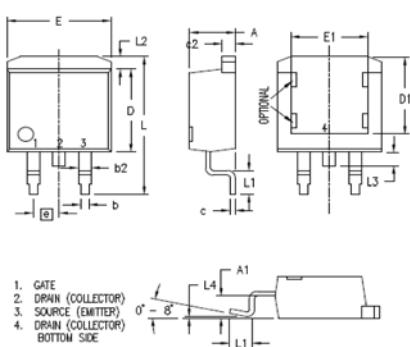
TO-252 (IXTY) Outline



Pins: 1 - Gate
3 - Source 2,4 - Drain

Dim.	Millimeter Min. Max.	Inches Min. Max.
A	2.19 2.38	0.086 0.094
A1	0.89 1.14	0.035 0.045
A2	0 0.13	0 0.005
b	0.64 0.89	0.025 0.035
b1	0.76 1.14	0.030 0.045
b2	5.21 5.46	0.205 0.215
c	0.46 0.58	0.018 0.023
c1	0.46 0.58	0.018 0.023
D	5.97 6.22	0.235 0.245
D1	4.32 5.21	0.170 0.205
E	6.35 6.73	0.250 0.265
E1	4.32 5.21	0.170 0.205
e	2.28 BSC	0.090 BSC
e1	4.57 BSC	0.180 BSC
H	9.40 10.42	0.370 0.410
L	0.51 1.02	0.020 0.040
L1	0.64 1.02	0.025 0.040
L2	0.89 1.27	0.035 0.050
L3	2.54 2.92	0.100 0.115

TO-263 (IXTA) Outline



SYM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.160	.190	4.06	4.83
A1	.080	.110	2.03	2.79
b	.020	.039	0.51	0.99
b2	.045	.055	1.14	1.40
c	.016	.029	0.40	0.74
C2	.045	.055	1.14	1.40
D	.340	.380	8.64	9.65
D1	.315	.350	8.00	8.89
E	.380	.410	9.65	10.41
E1	.245	.320	6.22	8.13
e	.100	BSC	2.54	BSC
L	.575	.625	14.61	15.88
L1	.090	.110	2.29	2.79
L2	.040	.055	1.02	1.40
L3	.050	.070	1.27	1.78
L4	0	.005	0	0.13

IXYS Reserves the Right to Change Limits, Test Conditions, and Dimensions.

IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents: 4,835,592 4,931,844 5,049,961 5,237,481 6,162,665 6,404,065 B1 6,683,344 6,727,585 7,005,734 B2 7,157,338B2 4,850,072 5,017,508 5,063,307 5,381,025 6,259,123 B1 6,534,343 6,710,405 B2 6,759,692 7,063,975 B2 4,881,106 5,034,796 5,187,117 5,486,715 6,306,728 B1 6,583,505 6,710,463 6,771,478 B2 7,071,537

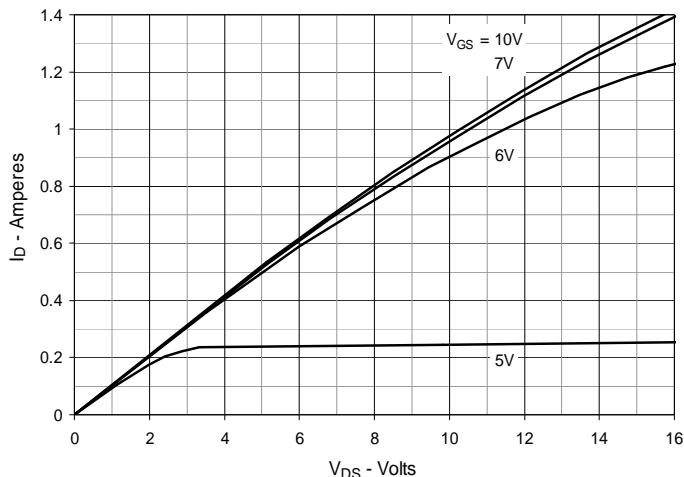
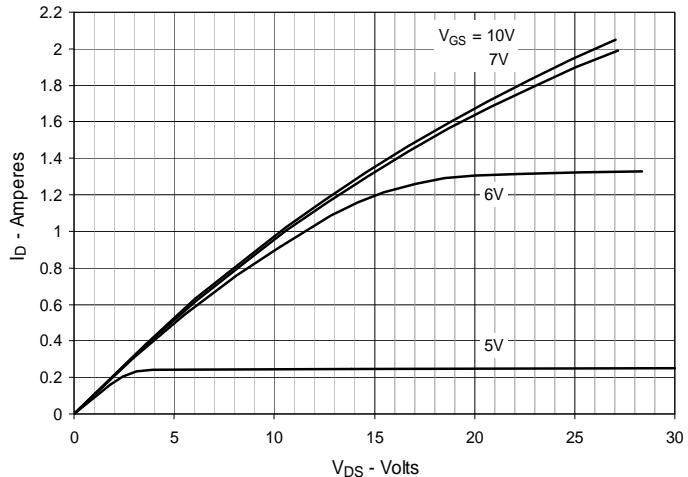
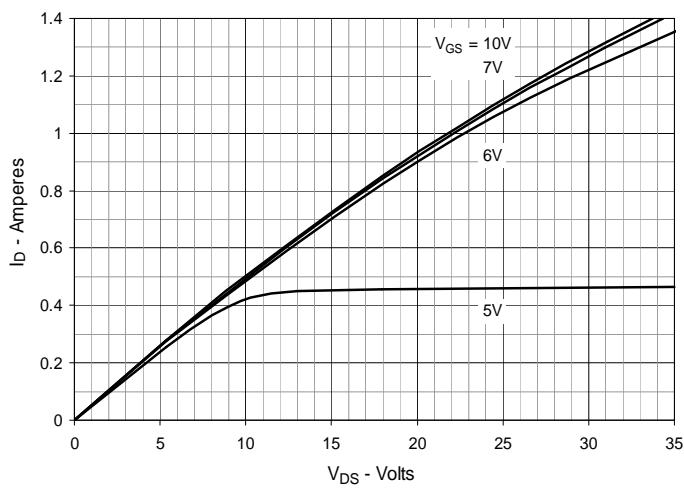
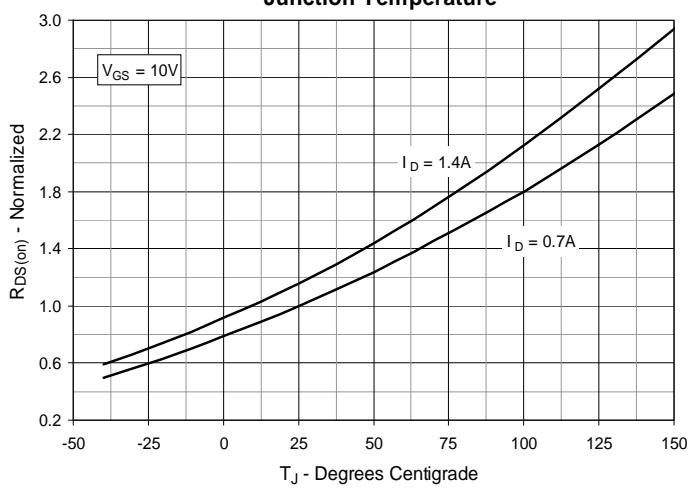
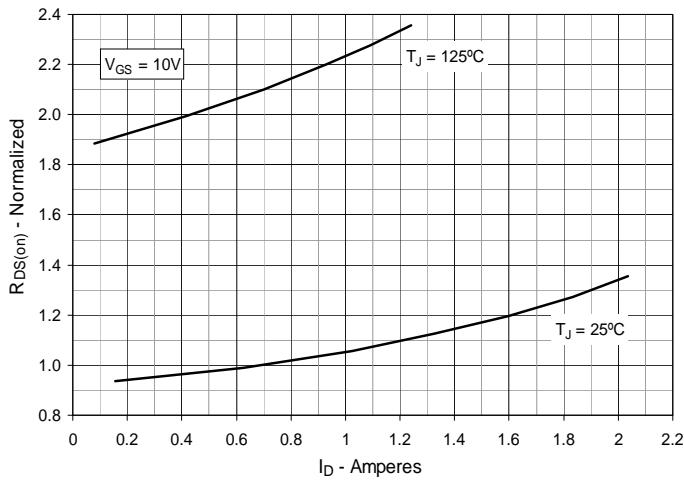
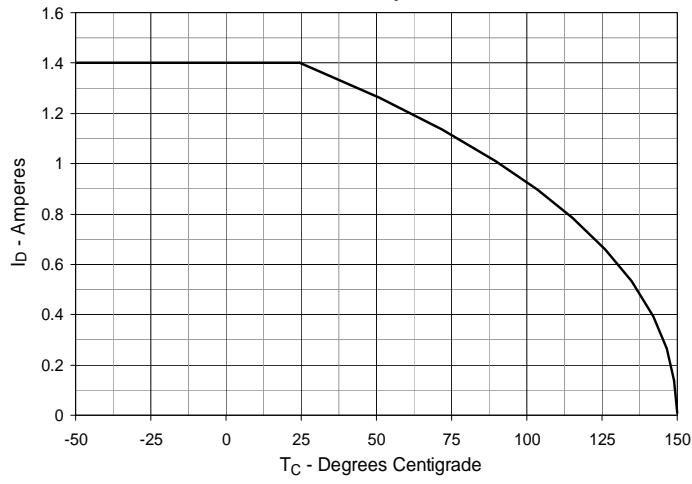
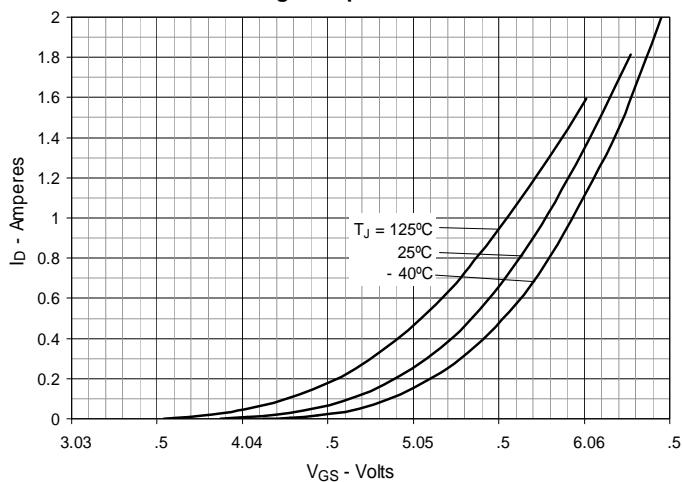
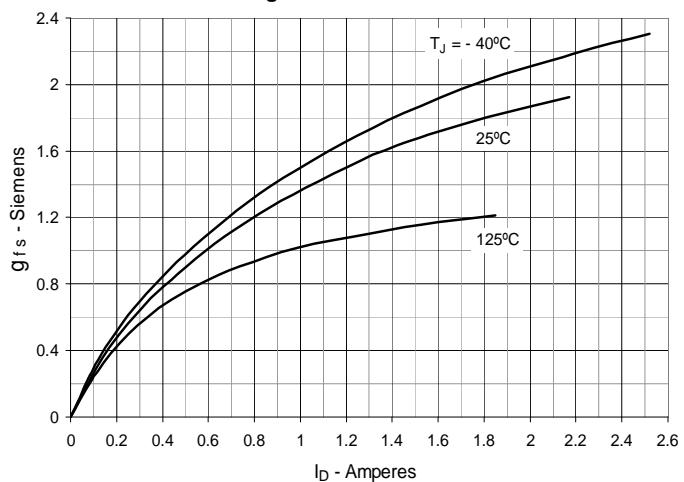
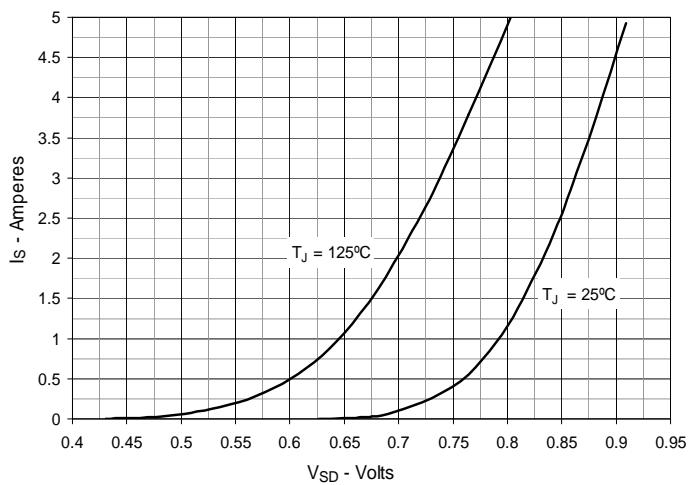
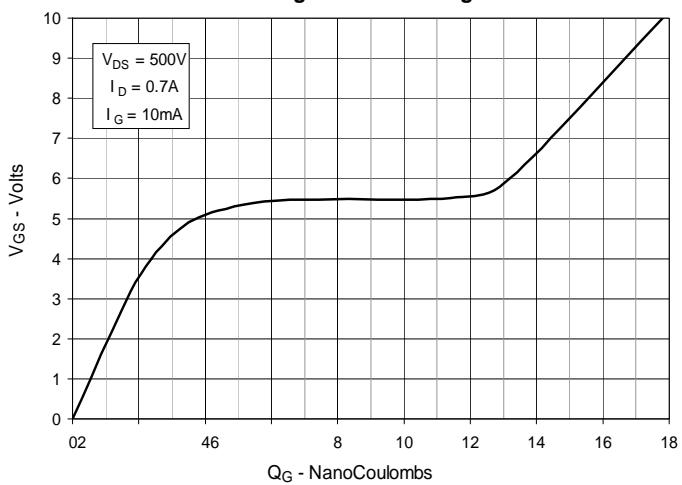
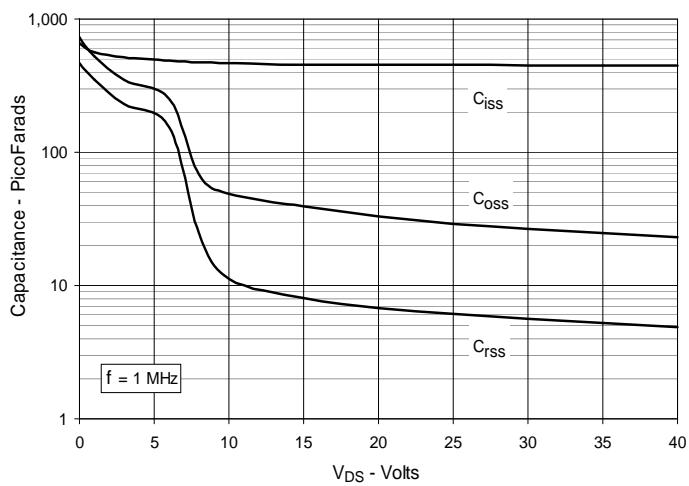
Fig. 1. Output Characteristics @ $T_J = 25^\circ\text{C}$

Fig. 2. Extended Output Characteristics @ $T_J = 25^\circ\text{C}$

Fig. 3. Output Characteristics @ $T_J = 125^\circ\text{C}$

Fig. 4. $R_{DS(on)}$ Normalized to $I_D = 0.7\text{A}$ Value vs. Junction Temperature

Fig. 5. $R_{DS(on)}$ Normalized to $I_D = 0.7\text{A}$ Value vs. Drain Current

Fig. 6. Maximum Drain Current vs. Case Temperature


Fig. 7. Input Admittance

Fig. 8. Transconductance

Fig. 9. Forward Voltage Drop of Intrinsic Diode

Fig. 10. Gate Charge

Fig. 11. Capacitance

Fig. 12. Maximum Transient Thermal Impedance
